



## **SPECIFICATION**

• Supplier : Samsung electro-mechanics • Samsung P/N : CL21A106KOQNNNE

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 10 µF, 16V, ±10%, X5R, 0805

## A. Samsung Part Number

<u>CL</u> <u>21</u> <u>A</u> <u>106</u> <u>K</u> <u>O</u> <u>Q</u> <u>N</u> <u>N</u> <u>N</u> <u>E</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor			
2	Size	0805 (inch code)	L: 2	0 ± 0.15 mm	W: 1.25 ± 0.15 mm
3	Dielectric	X5R	(8	Inner electrode	Ni
4	Capacitance	<b>10</b> μF		Termination	Cu
(5)	Capacitance	±10 %		Plating	Sn 100% (Pb Free)
	tolerance		9	Product	Normal
6	Rated Voltage	16 V	C	Special	Reserved for future use
7	Thickness	1.25 ± 0.15 mm	1	Packaging	Embossed Type, 7" reel

## **B. Samsung Reliability Test and Judgement condition**

	Performance	Test condition			
Capacitance	Within specified tolerance	1kHz±10% 1.0±0.2Vrms			
Tan δ (DF)	0.1 max.				
Insulation	More than 100Mohm⋅ <i>μ</i> F	Rated Voltage 60~120 sec.			
Resistance					
Appearance	No abnormal exterior appearance	Visual inspection			
Withstanding	No dielectric breakdown or	250% of the rated voltage			
Voltage	mechanical breakdown				
Temperature	X5R				
Characteristics	(From -55℃ to 85℃, Capacitance change should be within ±15%)				
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.			
of Termination	terminal electrode				
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)			
		with 1.0mm/sec.			
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder			
	is to be soldered newly	245±5℃, 3±0.3sec.			
		(preheating : 80~120 ℃ for 10~30sec.)			
Resistance to	Capacitance change: within ±7.5%	Solder pot : 270±5℃, 10±1sec.			
Soldering heat	Tan δ, IR : initial spec.				

	Performance	Test condition	
Vibration Test	Capacitance change: within ±5%	Amplitude : 1.5mm	
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)	
		2hours × 3 direction (x, y, z)	
Moisture	Capacitance change: within ±12.5%	With rated voltage	
Resistance	Tan δ : 0.2 max	40±2℃, 90~95%RH, 500+12/-0 hour	
	IR : More than 12.5MΩ·μF		
High Temperature	Capacitance change : within ±12.5%	With 100% of the rated voltage	
Resistance	Tan δ : 0.2 max	Max. operating temperature	
	IR : More than 25MΩ·μF		
		1000+48/-0 hour	
Temperature	Capacitance change: within ±7.5%	1 cycle condition	
Cycling	Tan δ, IR : initial spec.	Min. operating temperature → 25°C	
		→ Max. operating temperature → 25°C	
		5 cycles test	

## C. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260+0/-5  $^{\circ}$ C , 10sec. Max )

<sup>\*</sup> For the more detail Specification, Please refer to the Samsung MLCC catalogue.